



U.S.S.N. 10/788,756

IN THE CLAIMS

Please cancel Claims 1,3-8 and 17-20 without prejudice.

Listing of Claims

1-8 (cancelled)

9. (previously presented) A particle-removing wafer, comprising:

a support body; said support body comprises a silicon wafer;

a resilient layer carried by said support body;

an adhesive layer carried by said resilient layer; and

a particle-adherent layer having a particle-adherent surface carried by said adhesive layer, said particle-adherent layer comprises a tetrafluoroethylene film.

10-12 (cancelled)

13. (original) The particle-removing wafer of claim 9 wherein said adhesive layer comprises a pair of adhesive surfaces.

14-20 (cancelled)